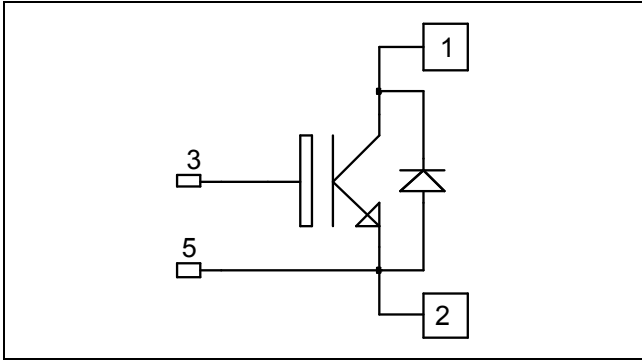


Single switch NPT IGBT Power Module

$V_{CES} = 1200V$
 $I_C = 400A @ T_c = 80^\circ C$



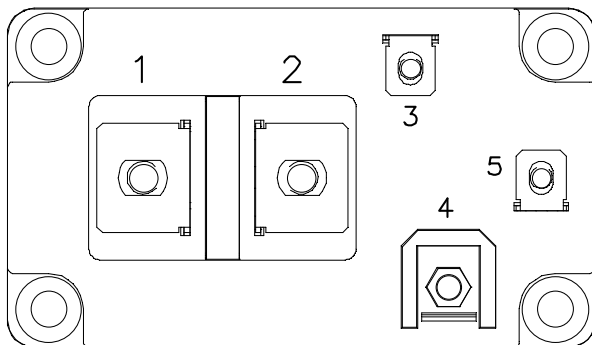
Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

Features

- Non Punch Through (NPT) FAST IGBT
 - Low voltage drop
 - Low tail current
 - Switching frequency up to 50 kHz
 - Soft recovery parallel diodes
 - Low diode VF
 - Low leakage current
 - RBSOA and SCSOA rated

- Kelvin emitter for easy drive
- M6 connectors for power
- M4 connectors for signal
- High level of integration



Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive T_c of V_{CESat}
- RoHS Compliant

Absolute maximum ratings

| Symbol | Parameter | Max ratings | Unit |
|-----------|---------------------------------------|---------------------|--------------|
| V_{CES} | Collector - Emitter Breakdown Voltage | 1200 | V |
| I_C | Continuous Collector Current | $T_c = 25^\circ C$ | 510 |
| | | $T_c = 80^\circ C$ | 400 |
| I_{CM} | Pulsed Collector Current | $T_c = 25^\circ C$ | 800 |
| V_{GE} | Gate - Emitter Voltage | ± 20 | V |
| P_D | Maximum Power Dissipation | $T_c = 25^\circ C$ | 2500 |
| RBSOA | Reverse Bias Safe Operating Area | $T_j = 150^\circ C$ | 800A @ 1100V |

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|---------------|--------------------------------------|------------------------------------------------|---------------------------|-----|-----|------|
| I_{CES} | Zero Gate Voltage Collector Current | $V_{GE} = 0\text{V}$; $V_{CE} = 1200\text{V}$ | | | 5 | mA |
| $V_{CE(sat)}$ | Collector Emitter saturation Voltage | $V_{GE} = 15\text{V}$ $I_C = 400\text{A}$ | $T_j = 25^\circ\text{C}$ | 3.2 | 3.7 | V |
| | | | $T_j = 125^\circ\text{C}$ | 3.9 | | |
| $V_{GE(th)}$ | Gate Threshold Voltage | $V_{GE} = V_{CE}$, $I_C = 16\text{mA}$ | 4.5 | 5.5 | 6.5 | V |
| I_{GES} | Gate – Emitter Leakage Current | $V_{GE} = 20\text{V}$, $V_{CE} = 0\text{V}$ | | | 400 | nA |

Dynamic Characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|--------------|------------------------------|------------------------------------------------------------------------------------------------------------|---------------------------|------|-----|---------------|
| C_{ies} | Input Capacitance | $V_{GE} = 0\text{V}$ | | 26 | | nF |
| C_{oes} | Output Capacitance | $V_{CE} = 25\text{V}$ | | 4 | | |
| C_{res} | Reverse Transfer Capacitance | $f = 1\text{MHz}$ | | 2 | | |
| Q_G | Gate charge | $V_{GE} = \pm 15\text{V}$, $I_C = 400\text{A}$ $V_{CE} = 600\text{V}$ | | 4.2 | | μC |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive Switching (25°C) | | 100 | | ns |
| T_r | Rise Time | $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ | | 60 | | |
| $T_{d(off)}$ | Turn-off Delay Time | $I_C = 400\text{A}$ | | 530 | | |
| T_f | Fall Time | $R_G = 2.2\Omega$ | | 40 | | |
| $T_{d(on)}$ | Turn-on Delay Time | Inductive Switching (125°C) | | 110 | | ns |
| T_r | Rise Time | $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ | | 70 | | |
| $T_{d(off)}$ | Turn-off Delay Time | $I_C = 400\text{A}$ | | 550 | | |
| T_f | Fall Time | $R_G = 2.2\Omega$ | | 50 | | |
| E_{on} | Turn-on Switching Energy | $V_{GE} = 15\text{V}$ $V_{Bus} = 600\text{V}$ | $T_j = 125^\circ\text{C}$ | 22 | | mJ |
| E_{off} | Turn-off Switching Energy | $I_C = 400\text{A}$ $R_G = 2.2\Omega$ | $T_j = 125^\circ\text{C}$ | 29 | | |
| I_{sc} | Short Circuit data | $V_{GE} \leq 15\text{V}$; $V_{Bus} = 900\text{V}$ $t_p \leq 10\mu\text{s}$; $T_j = 125^\circ\text{C}$ | | 2600 | | A |

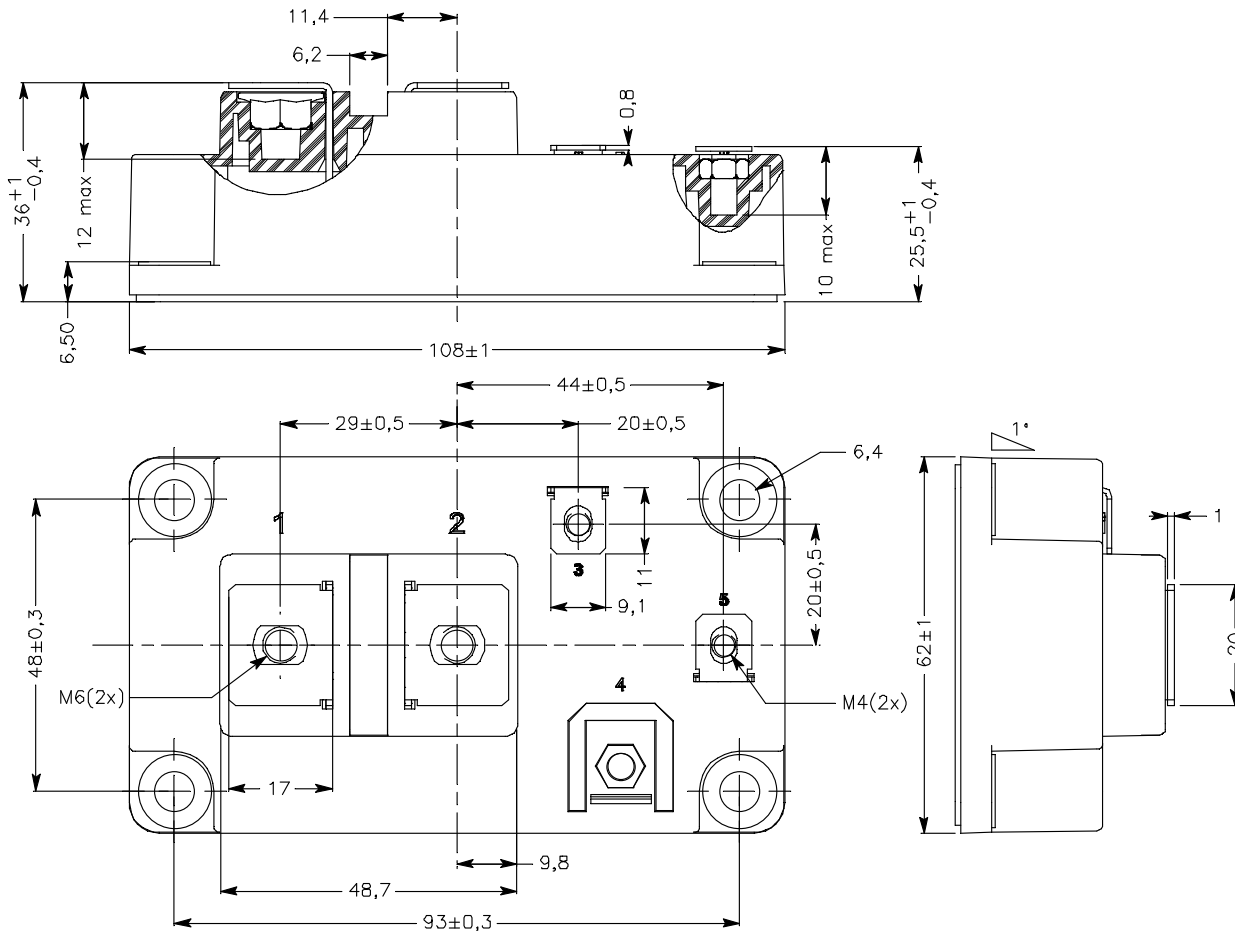
Reverse diode ratings and characteristics

| Symbol | Characteristic | Test Conditions | Min | Typ | Max | Unit |
|-----------|-----------------------------------------|----------------------------------------------------------------------------------|---------------------------|-----|------|---------------|
| V_{RRM} | Maximum Peak Repetitive Reverse Voltage | | 1200 | | | V |
| I_{RRM} | Maximum Reverse Leakage Current | $V_R = 1200\text{V}$ | $T_j = 25^\circ\text{C}$ | | 750 | μA |
| | | | $T_j = 125^\circ\text{C}$ | | 1000 | |
| I_F | DC Forward Current | | $T_c = 80^\circ\text{C}$ | 400 | | A |
| V_F | Diode Forward Voltage | $I_F = 400\text{A}$ | $T_j = 25^\circ\text{C}$ | 2.1 | | V |
| | | | $T_j = 125^\circ\text{C}$ | 1.9 | | |
| t_{rr} | Reverse Recovery Time | $I_F = 400\text{A}$ $V_R = 600\text{V}$ $di/dt = 4000\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$ | 120 | | ns |
| | | | $T_j = 125^\circ\text{C}$ | 210 | | |
| Q_{rr} | Reverse Recovery Charge | | $T_j = 25^\circ\text{C}$ | 26 | | μC |
| | | | $T_j = 125^\circ\text{C}$ | 64 | | |
| E_{rr} | Reverse Recovery Energy | | $T_j = 25^\circ\text{C}$ | 16 | | mJ |
| | | | $T_j = 125^\circ\text{C}$ | 32 | | |

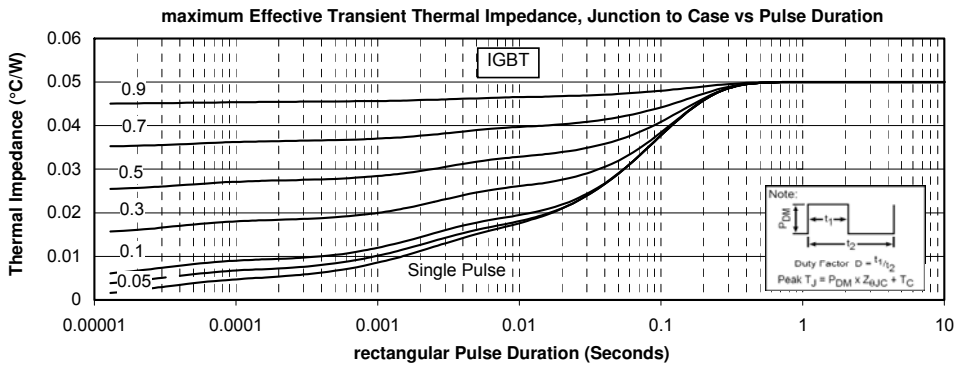
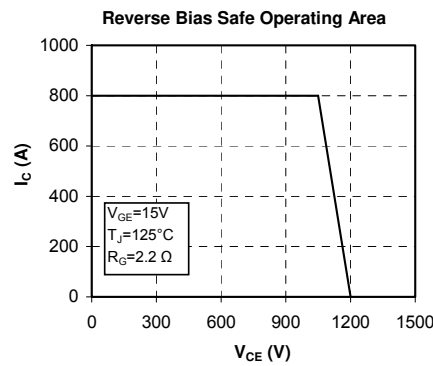
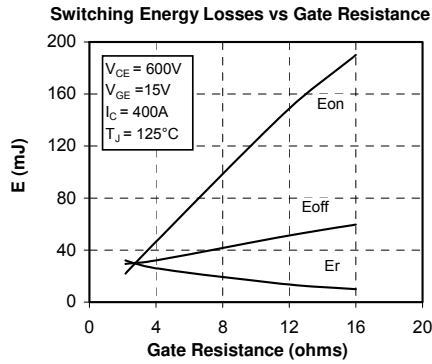
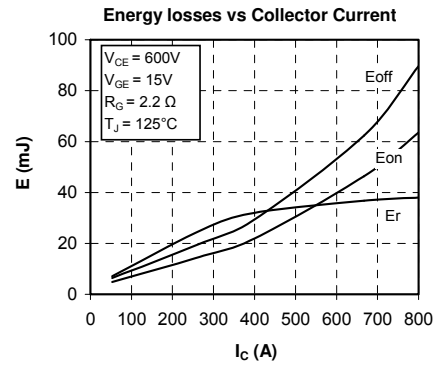
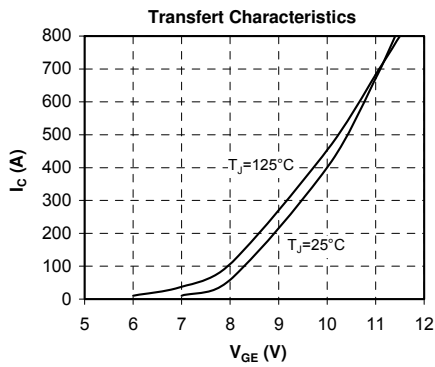
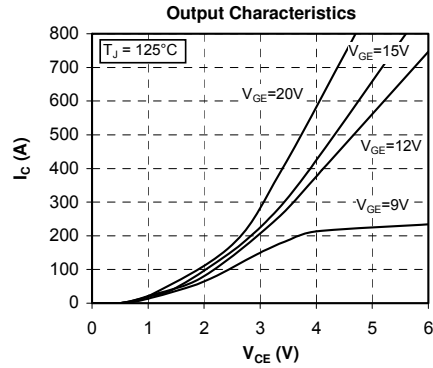
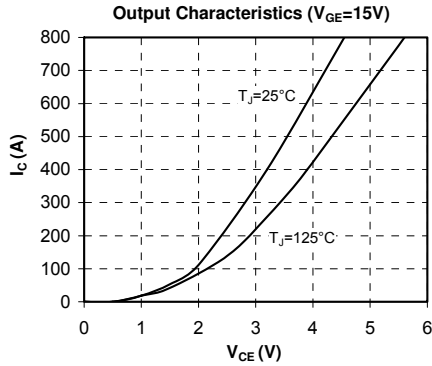
Thermal and package characteristics

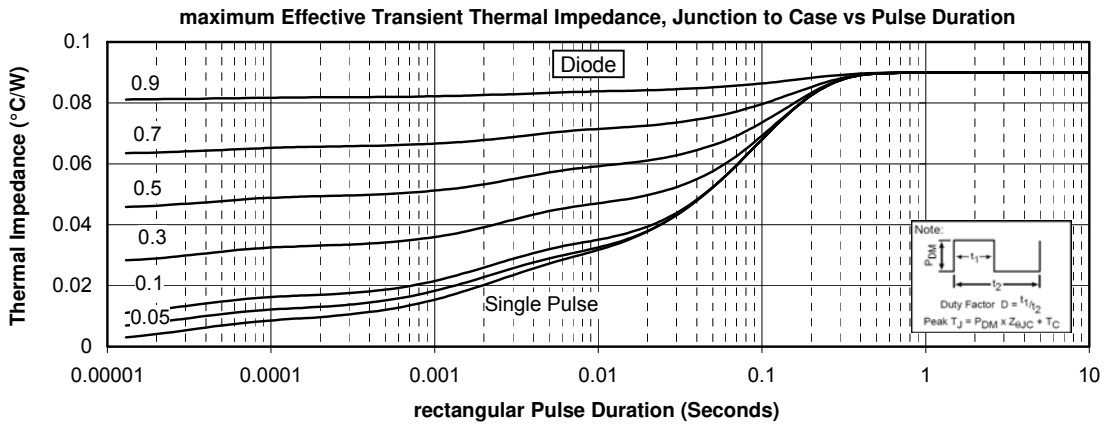
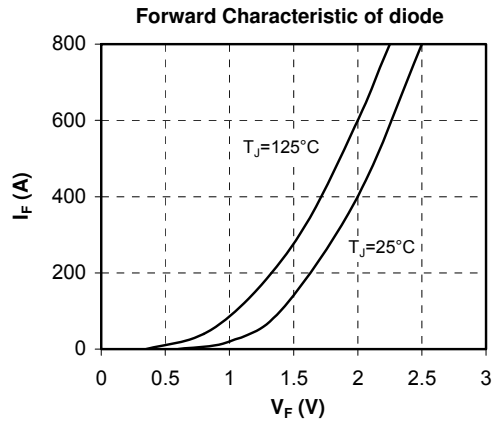
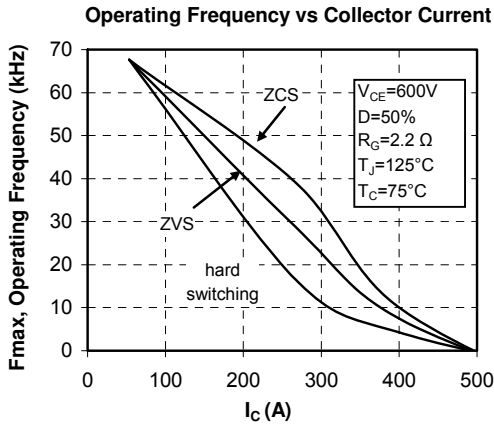
| Symbol | Characteristic | | Min | Typ | Max | Unit |
|-------------------|-----------------------------------------------------------------------------------------|-------|------|-----|------|------|
| R _{thJC} | Junction to Case Thermal Resistance | IGBT | | | 0.05 | °C/W |
| | | Diode | | | 0.09 | |
| V _{ISOL} | RMS Isolation Voltage, any terminal to case t = 1 min, I _{isol} < 1mA, 50/60Hz | | 2500 | | | V |
| T _J | Operating junction temperature range | | -40 | | 150 | °C |
| T _{STG} | Storage Temperature Range | | -40 | | 125 | |
| T _C | Operating Case Temperature | | -40 | | 125 | |
| Torque | Mounting torque | M6 | 3 | | 5 | N.m |
| | | M4 | 1 | | 2 | |
| Wt | Package Weight | | | | 350 | g |

D4 Package outline (dimensions in mm)



Typical Performance Curve





Microsemi reserves the right to change, without notice, the specifications and information contained herein

Microsemi's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 6,939,743 7,352,045 5,283,201 5,801,417 5,648,283 7,196,634 6,664,594 7,157,886 6,939,743 7,342,262 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.